

Power Consumption of Desktop and Mobile GPUs for IRSTAP Applications

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STAP-BOY: Concept

Problem:

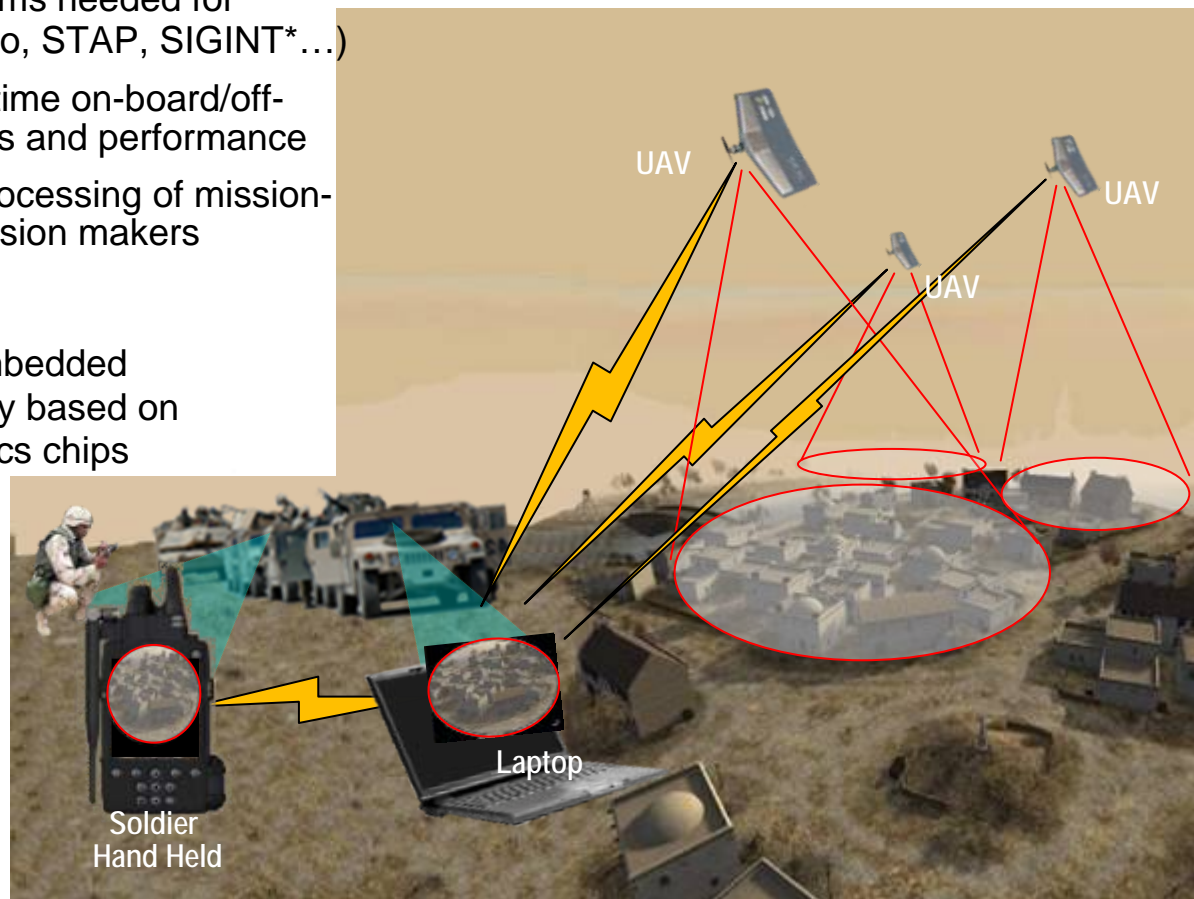
- Complex sensor modalities and algorithms needed for smaller platforms (SAR, 3D-motion video, STAP, SIGINT*...)
- Low-cost platform constraints limit real-time on-board/off-board and distributed sensing algorithms and performance
- Timely distribution, visualization, and processing of mission-critical data not available to tactical decision makers

STAP-BOY goal:

- Develop low-cost, scalable, teraflop, embedded multi-modal sensor processing capability based on commercial off-the-shelf (COTS) graphics chips

STAP-BOY approach:

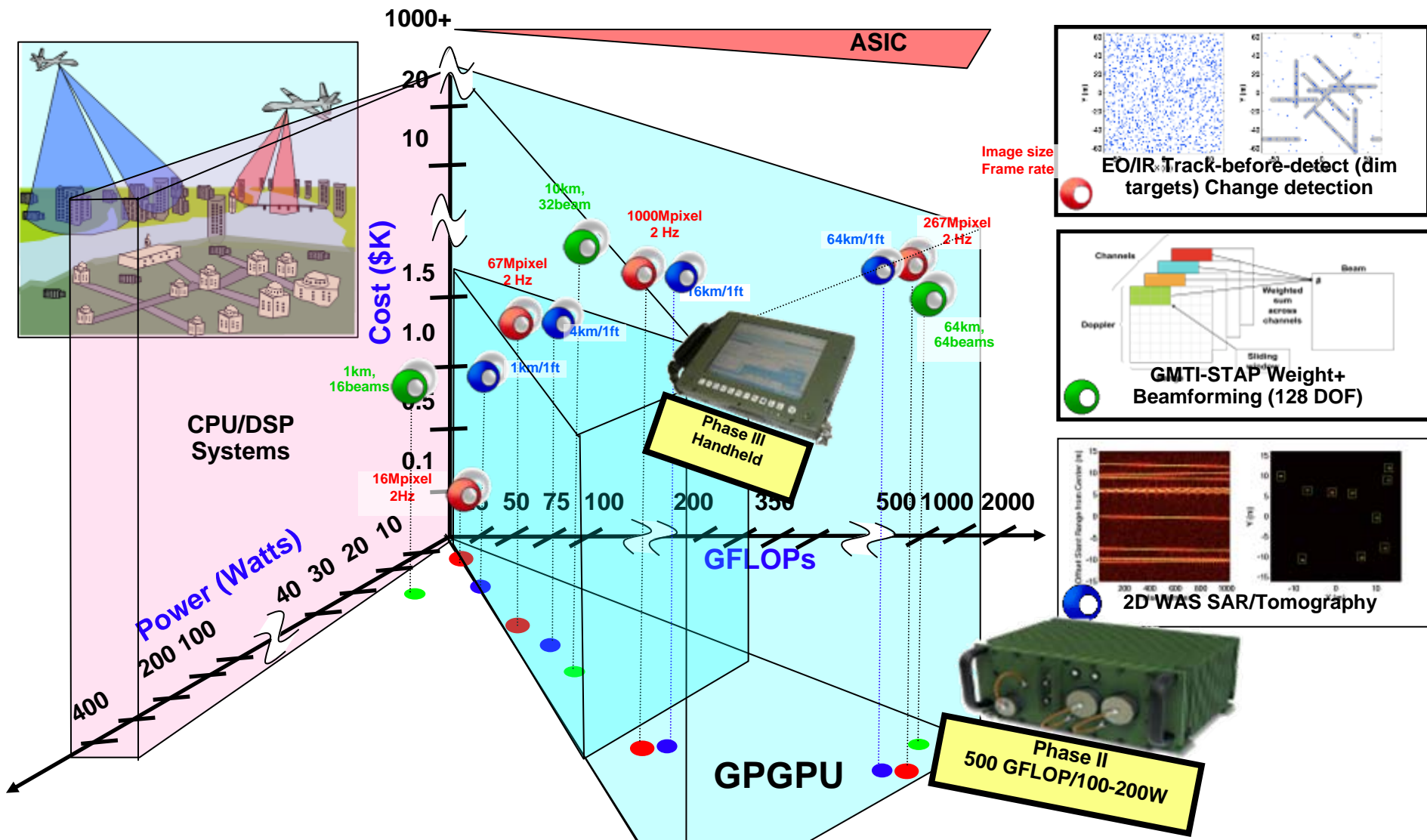
- Map complex algorithms to COTS graphics chips with open source graphics languages
- Prototype scalable parallel embedded computing architecture for handhelds to teraflop single card
- Demonstrate on available tactically representative sensor systems



Goal:

1/2 Teraflop
10 Mobile GPUs
100W Total Power
\$<15K

Applications Pull



Increasing Advanced Sensor Resolution Driving Processing Throughput Beyond CPU/DSP Capability In Communications and Cost-constrained Platforms

NVIDIA® GPU Performance/Power Study

GeForce™ 280 GTX **GeForce™ 8800 GTX**

GeForce™ 8800M GTX

Category	Desktop	Desktop	Mobile
Process (nm)	65	90	65
Transistor Count (Millions)	1400	681	754
Stream Processors	240	128	96
Shader Clock (GHz)	1.30	1.35	1.25
Memory Clock (MHz)	1107	900	800
Memory Amount (MB)	1024	768	512
Thermal Design Power (W)	236	177	65
Release Date	June 2008	November 2006	November 2007

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CPU vs. GPU: Head to Head (Floating Point)

Intel® quad-core Q9650

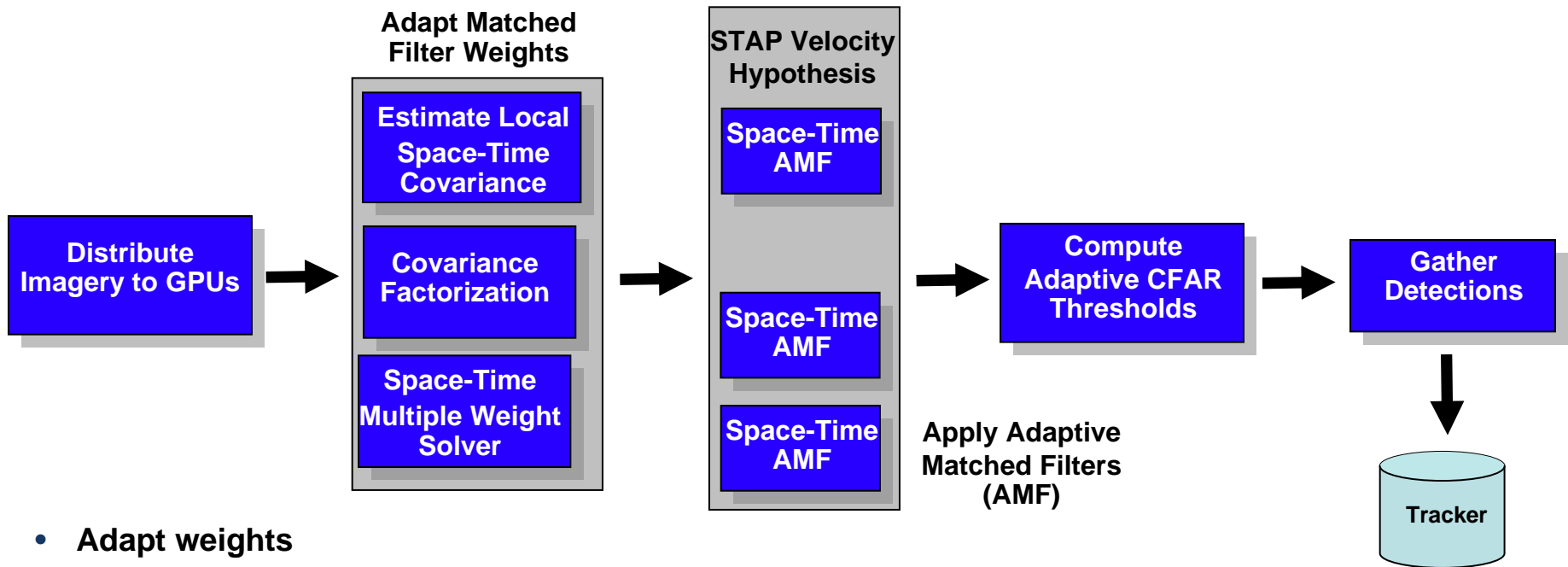
NVIDIA® 280 GTX

820 million	Transistors	1400 million
3.0 GHz	Clock Speed	1.3 GHz
4	Number of Cores	240
Serial	Programming Model	Highly parallel
Minimize latency	Design Goal	Maximize throughput
Complex cores: <ul style="list-style-type: none"> • Branch prediction • Out-of-order execution 	Design Approach	Simple cores: <ul style="list-style-type: none"> • Smaller caches • In-order execution
130 W	Thermal Design Power (TDP)	236 W
96 GFLOPS	Theoretical Max. Computation Rate (single precision)	933 GFLOPS

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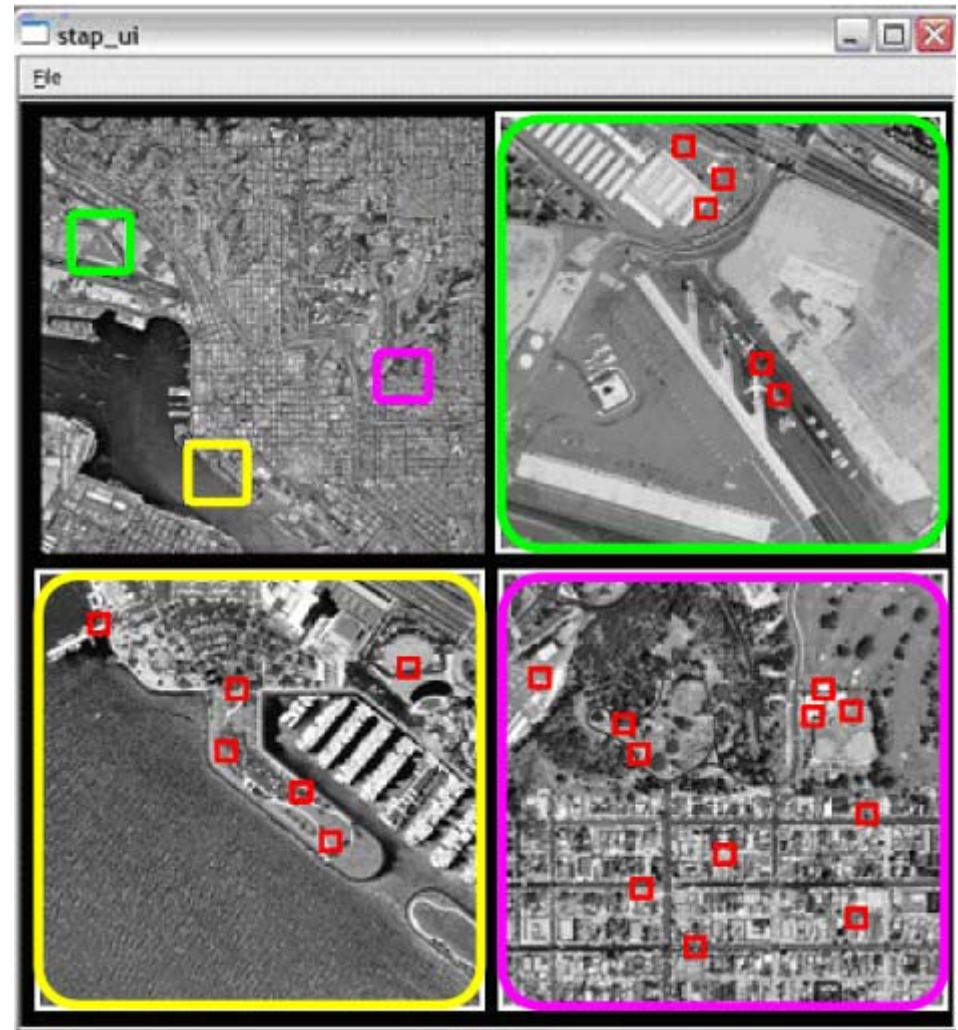
IRSTAP Application



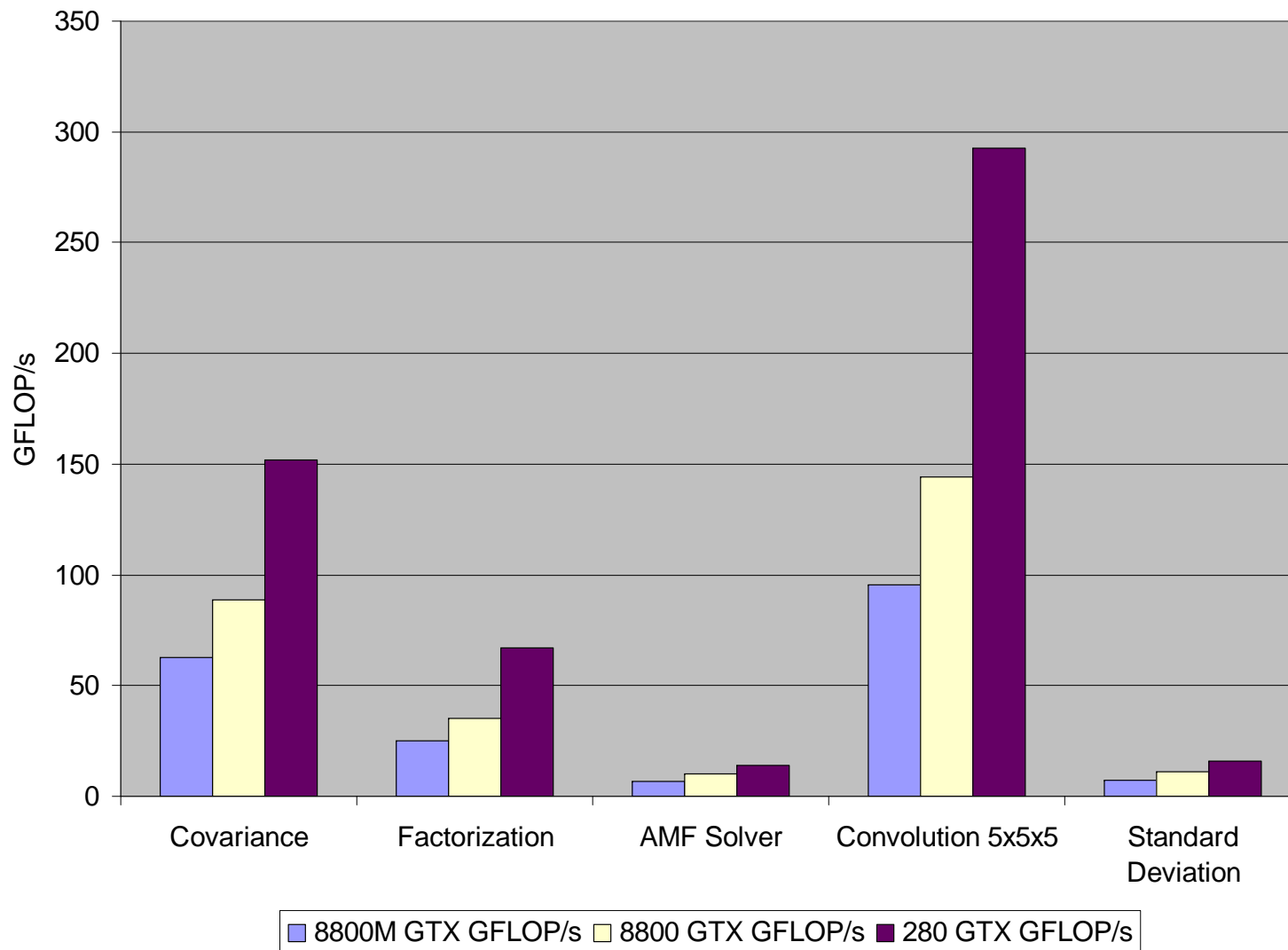
- **Adapt weights**
 - Covariance estimation
 - Covariance factorization
 - Find LMS solution
- **Apply AMF - convolution**
- **Compute CFAR thresholds**
 - Estimate standard deviation for each block
 - Adapt local standard deviations, excluding CUT
- **Gather detections into dense detection list**

IRSTAP Kernels

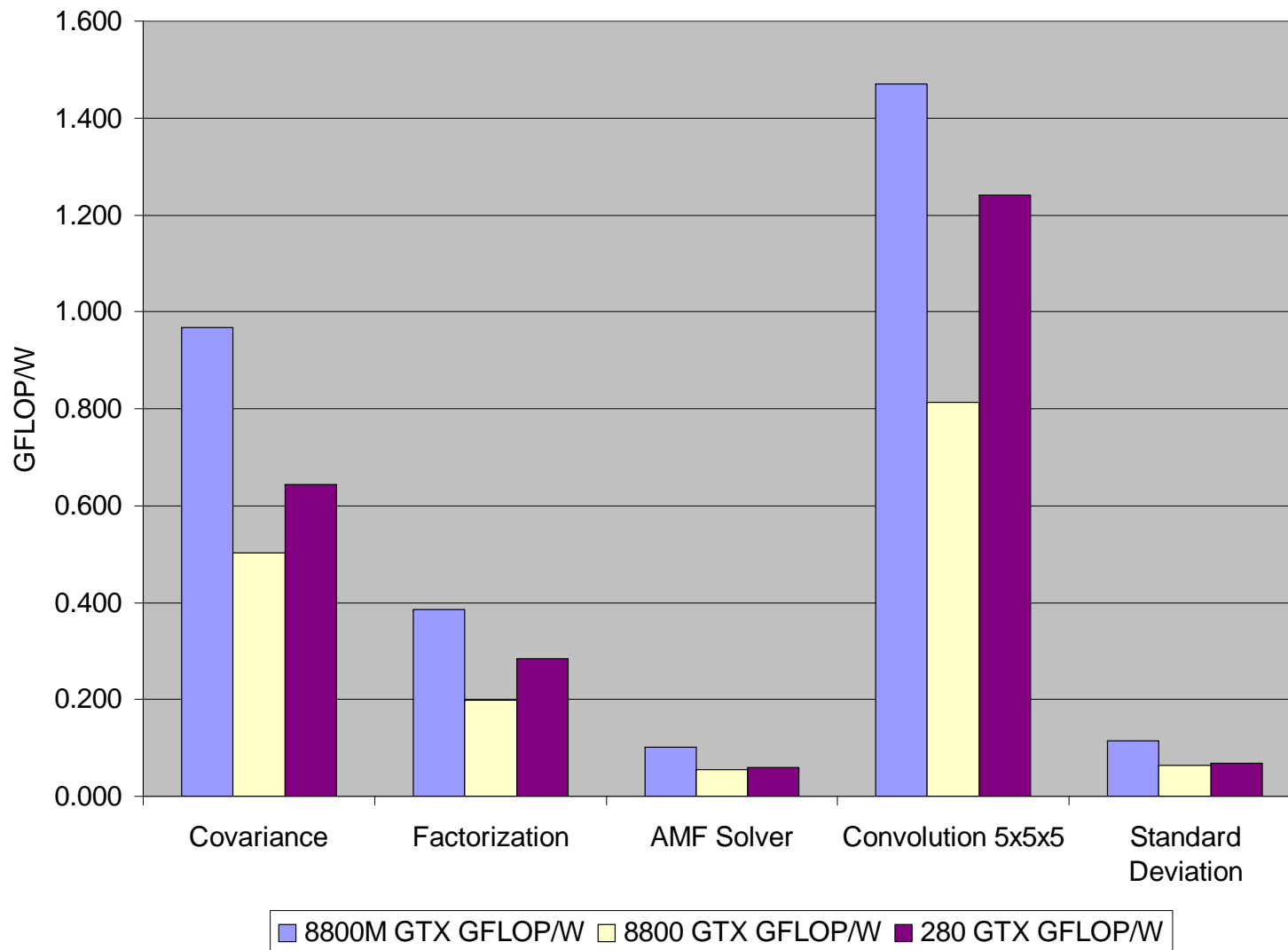
- **Image preprocessing**
 - Registration
 - Clutter subtraction
 - Spatial demeaning
- **Covariance calculation**
 - Ensemble generation
 - Covariance calculation
- **Weight adaptation**
 - Cholesky Factorization
 - Back and forward substitution
- **Weight application**
 - Convolution
- **Adaptive CFAR threshold adaptation**
 - Localized standard deviation
 - Complex mean kernel
- **Detection reduction**



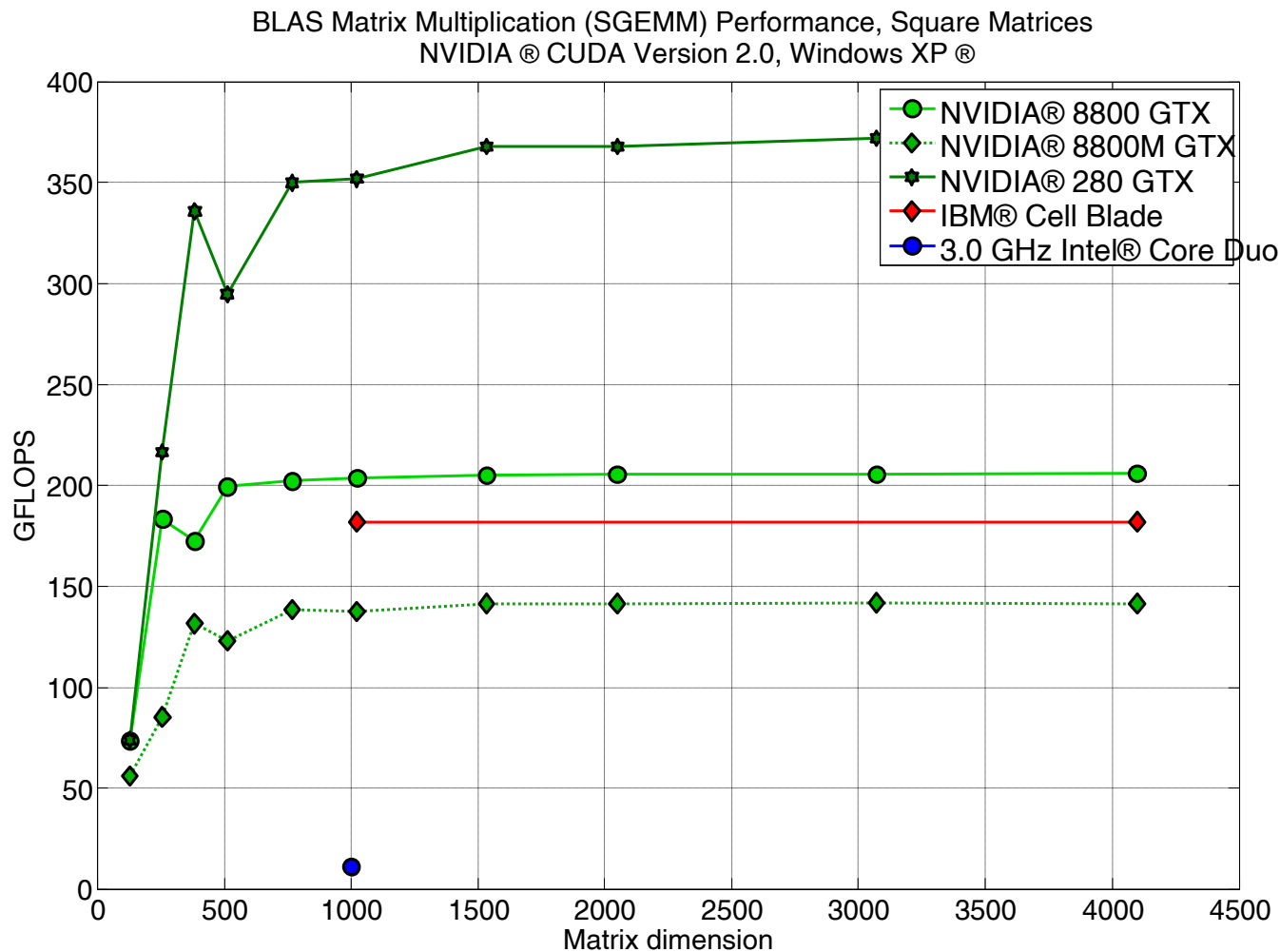
IRSTAP Benchmarks GFLOP/s



IRSTAP Benchmarks GFLOP/W



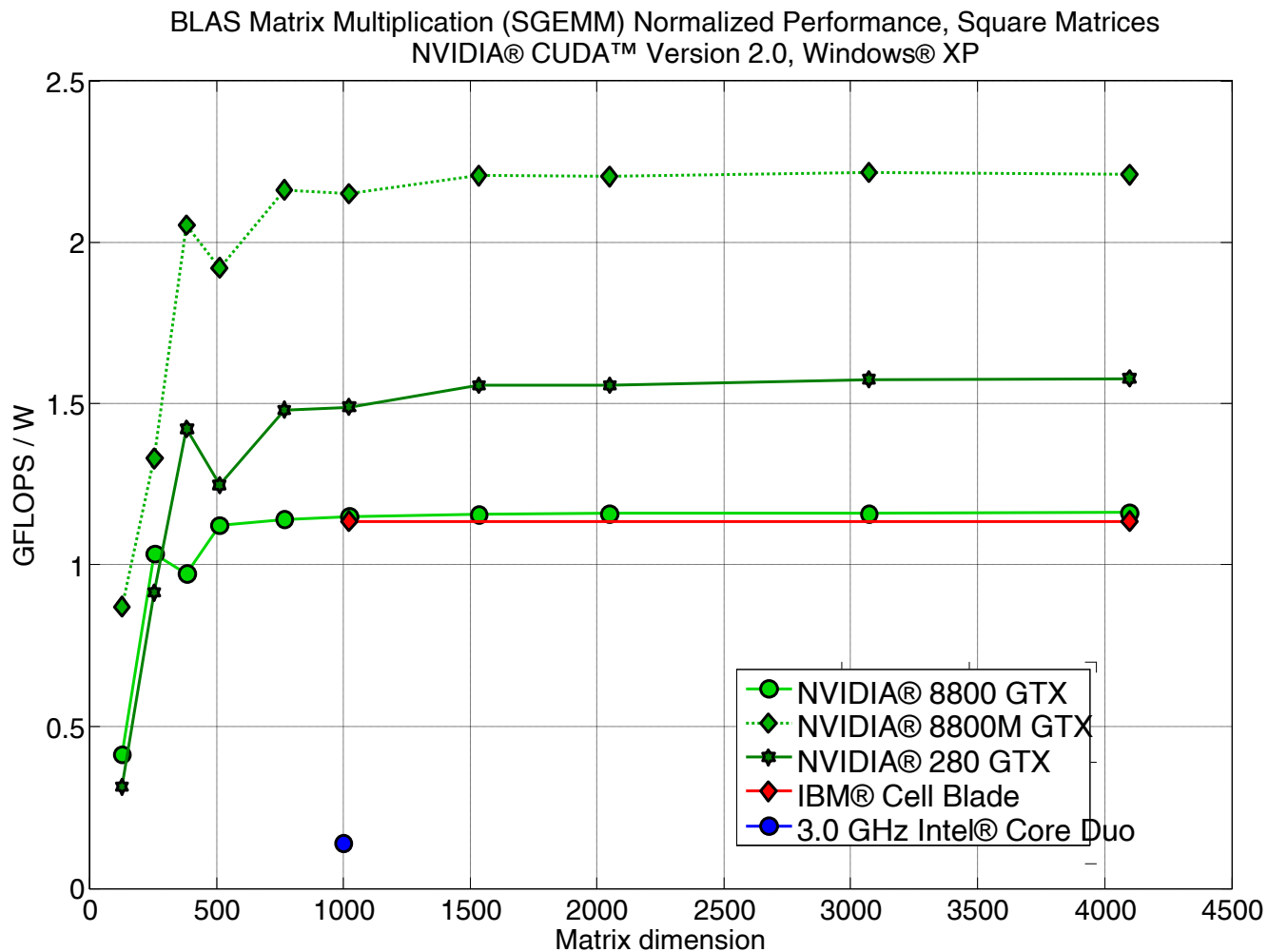
Matrix Multiplication GFLOP/s



GPU Multiplication is SGEMM is from the NVIDIA® library

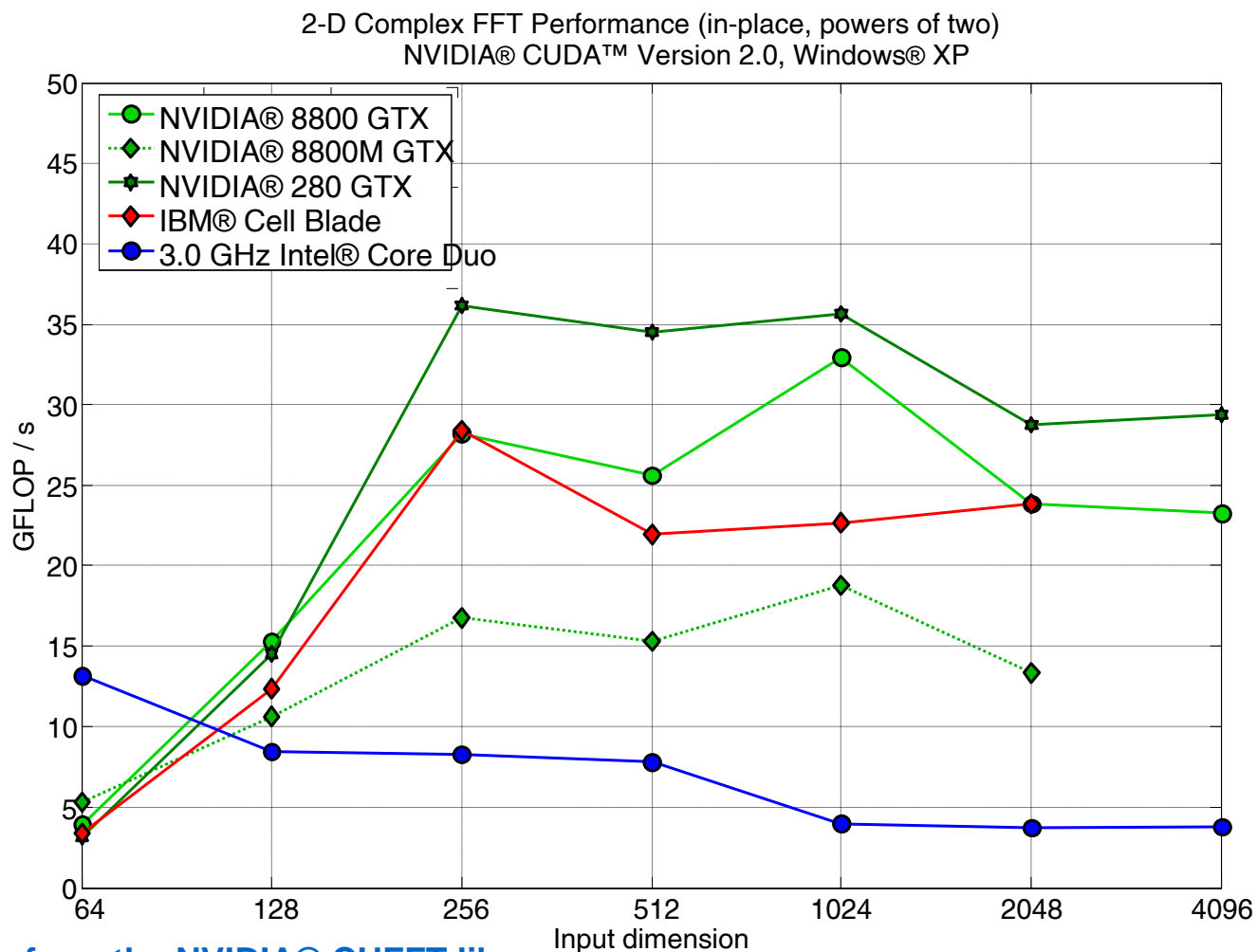
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Matrix Multiplication GFLOP/W



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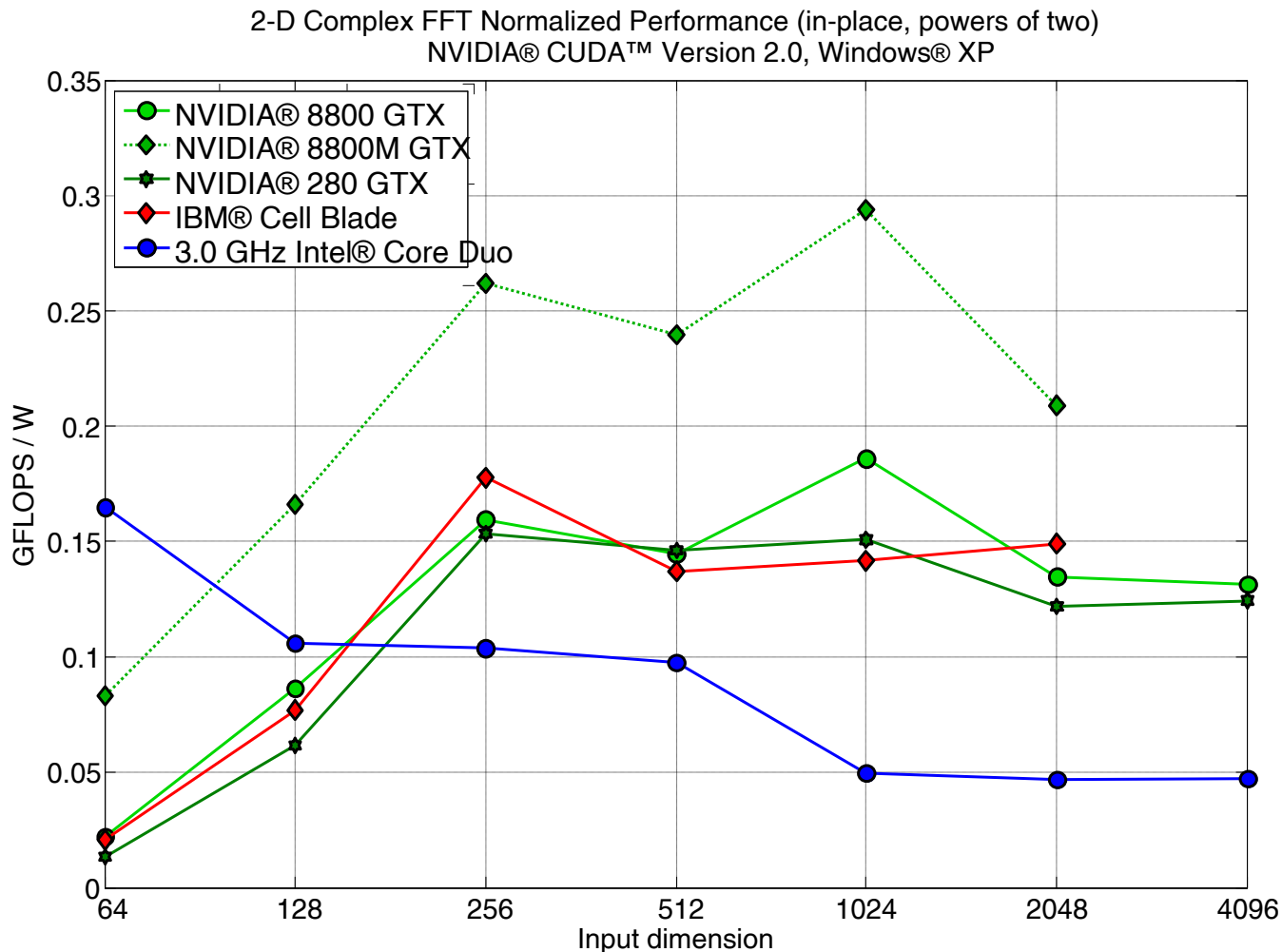
2D Complex FFT GFLOP/s



GPU FFT is from the NVIDIA® CUFFT library

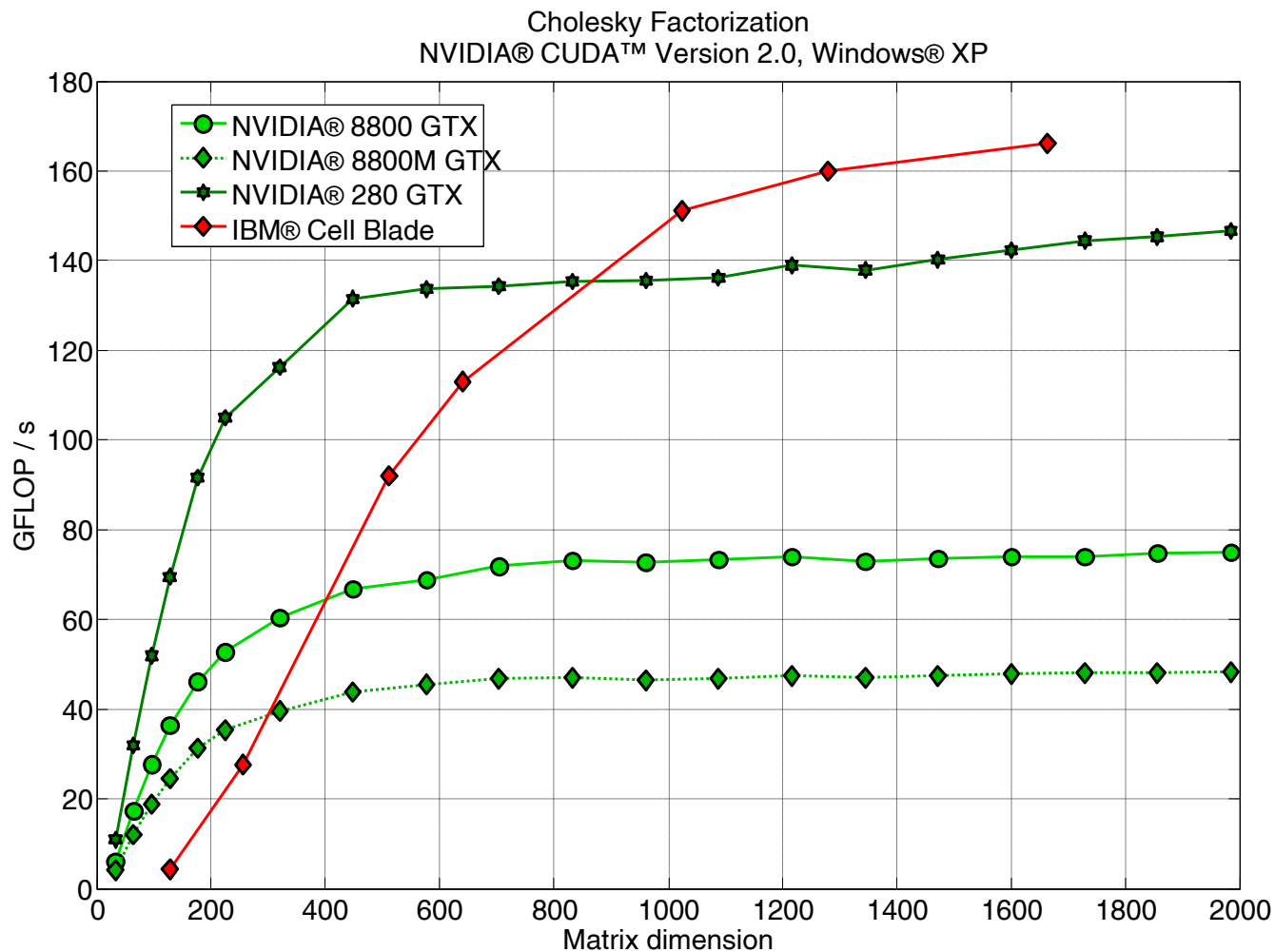
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2D Complex FFT GFLOP/W



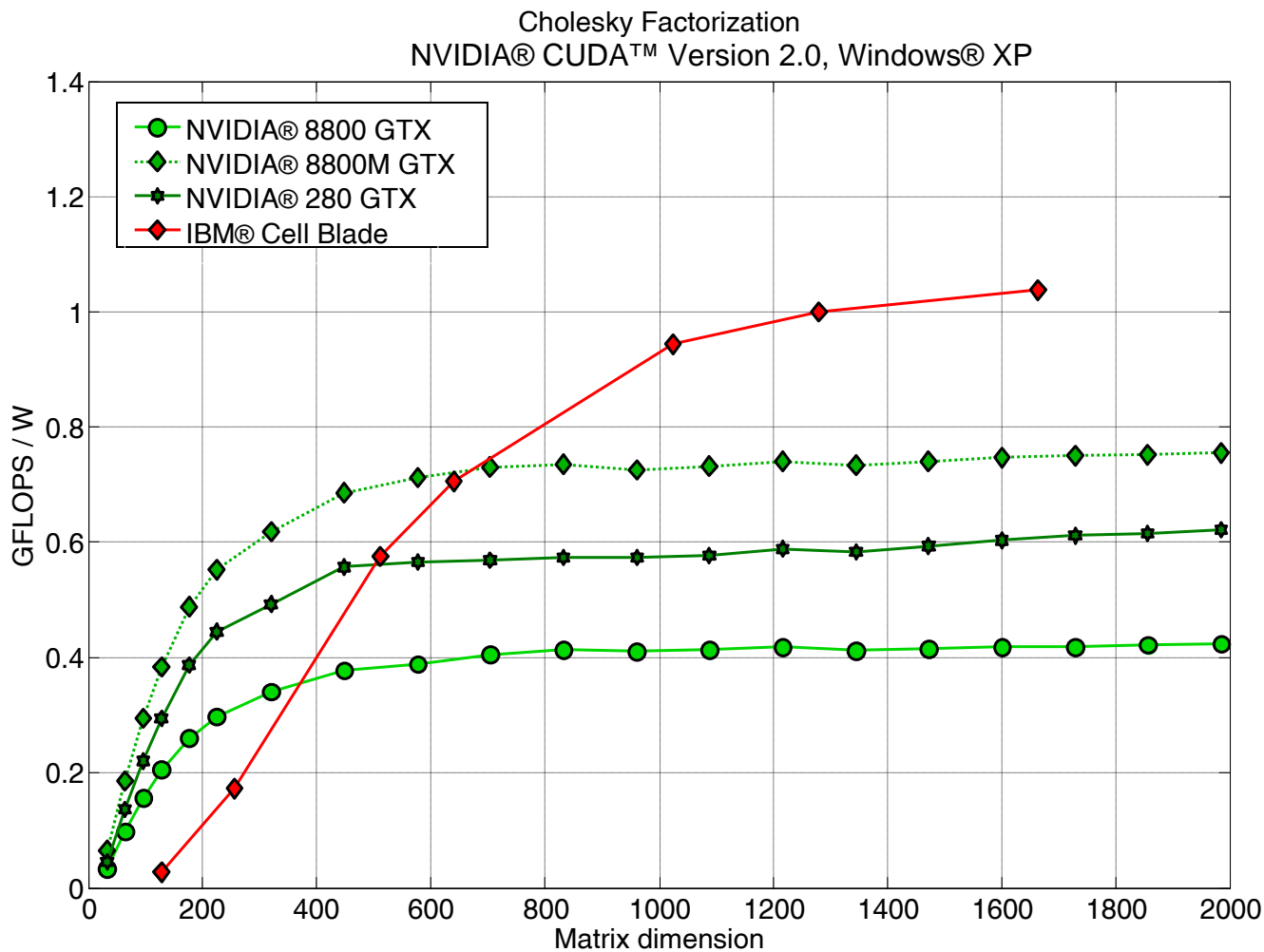
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Cholesky GFLOP/s



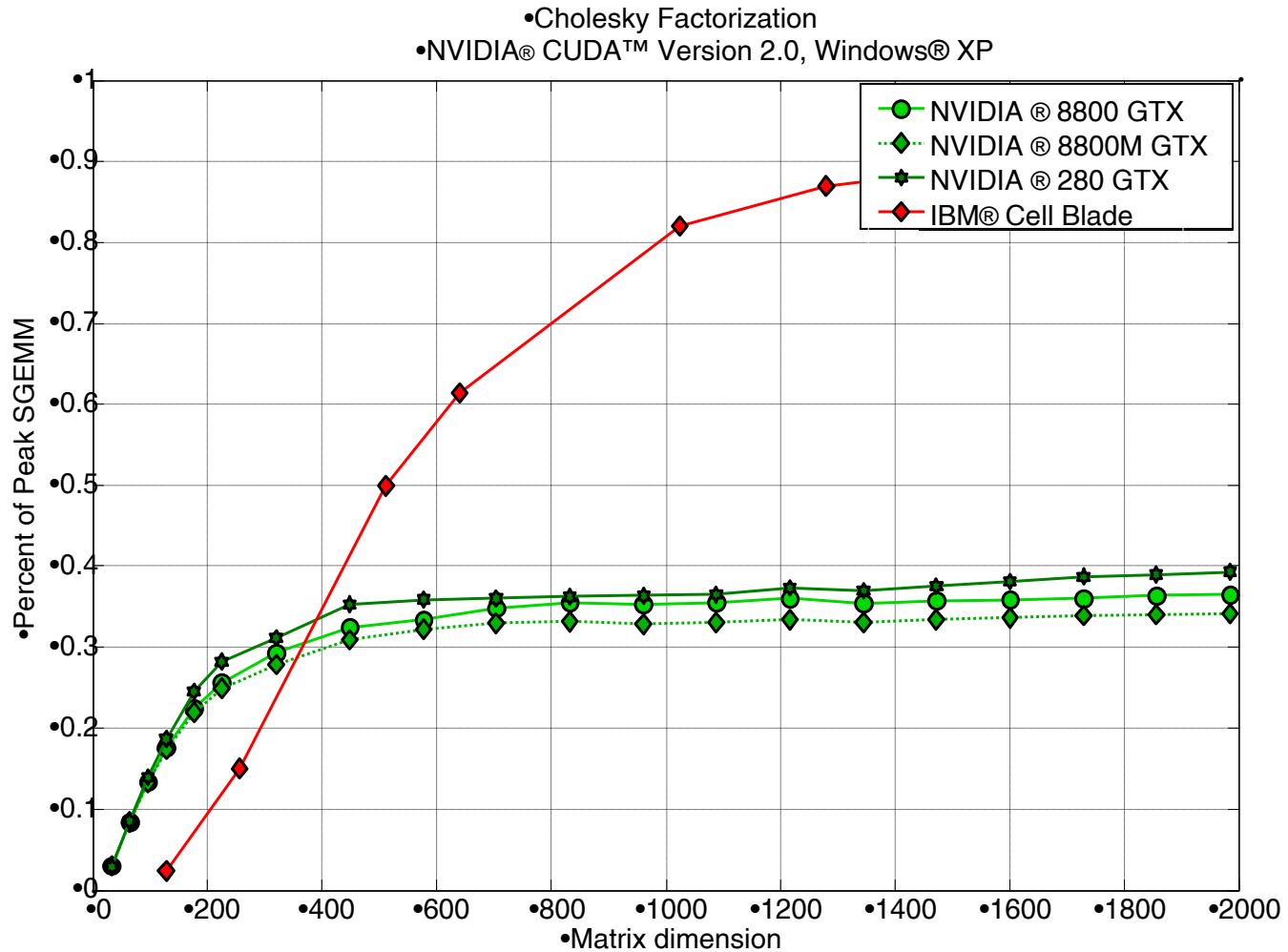
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Cholesky GFLOP/W



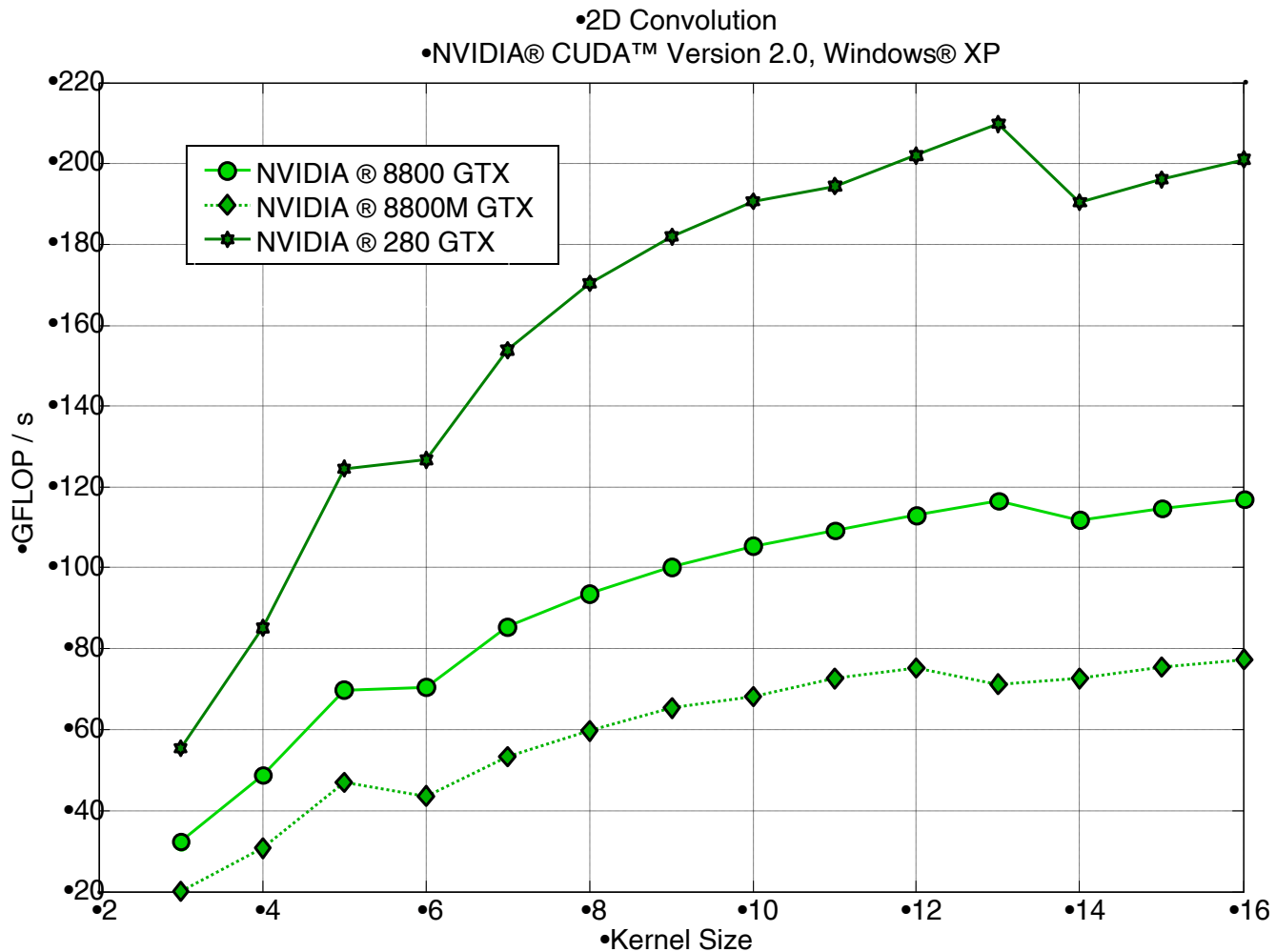
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Cholesky Efficiency



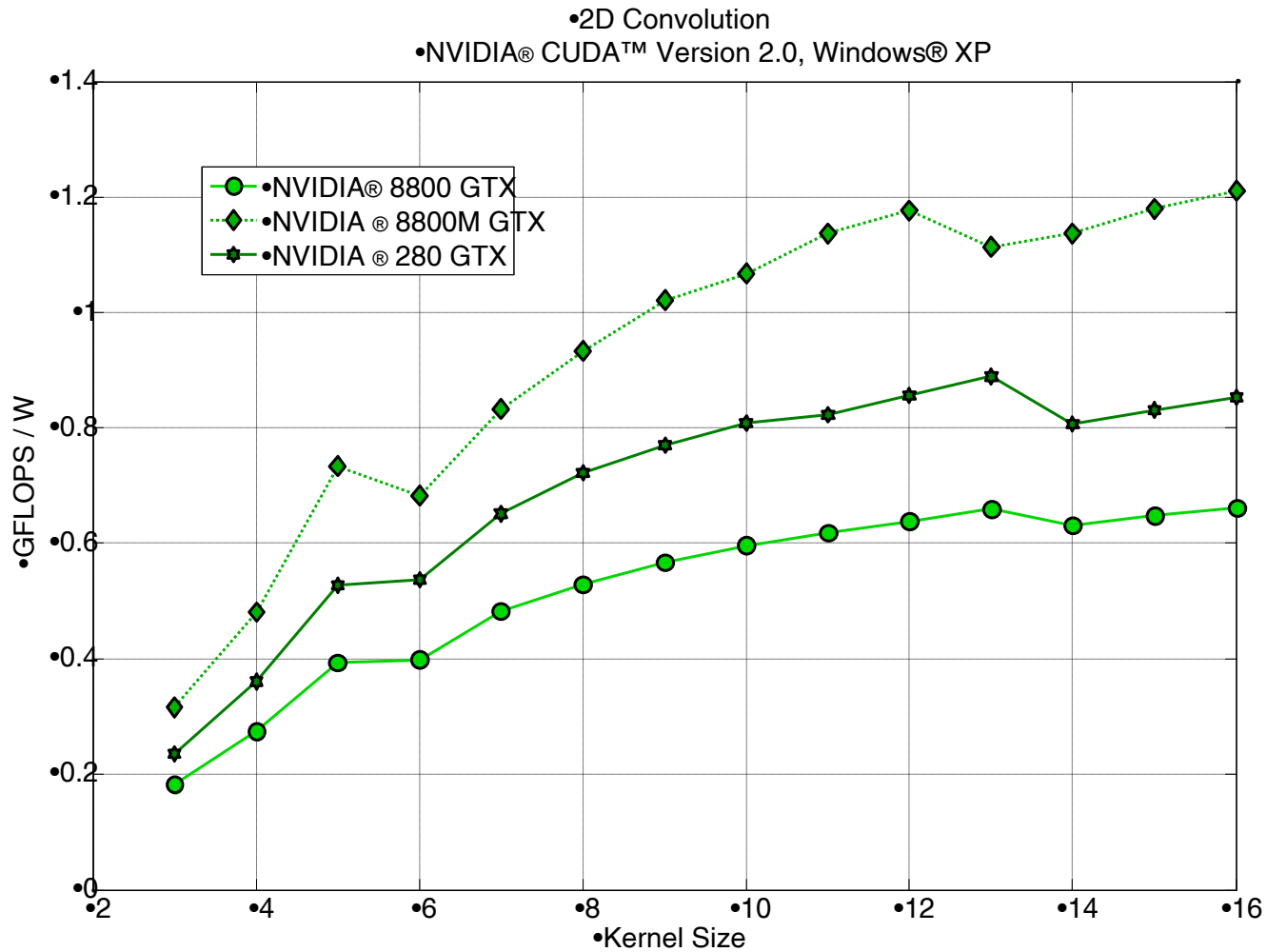
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2D Convolution GFLOP/s



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2D Convolution GFLOP/W



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Power Estimation

- **Using thermal design power (TDP) for each device**
 - NVIDIA® 8800 GTX 128SP 1.35Ghz – TDP: 177W
 - NVIDIA® 8800M GTX 96SP 1.25Ghz – TDP: 65W
 - NVIDIA® 280 GTX 240SP 1.30Ghz – TDP: 236W
- **Cell – estimating TDP: 160W with 90nm process**

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Questions ?

Just for comparison...

Assume Cell Processor power consumption is approximately
160 W

7000 ft at 32°C

Power

Cell Accelerator Board 2 with 4-GB DDR2 162W

Power is provided through the use of a single cable connector in addition to the 75W power provided through the PCI Express edge connector.

2 Cell Processors per blade

- Power consumption:
 - QS20: 315 watts maximum
 - QS20: 330 watts with 1 IB (#2945)
 - QS20: 345 watts with 2 IB (#2945)